

Notice of References Cited	Application/Control No. 10/042,097	Applicant(s)/Patent Under Reexamination DIXON ET AL.	
	Examiner John P Trimmings	Art Unit 2133	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	A	US-6,631,486	10-2003	Komatsu et al.	714/724
*	B	US-6,563,298	05-2003	Creek et al.	324/158.1
*	C	US-5,548,525	08-1996	Albee et al.	716/4
*	D	US-6,374,379	04-2002	Walker et al.	714/724
*	E	US-5,097,144	03-1992	Chang et al.	327/109
*	F	US-6,025,708	02-2000	Stickler, Heather L.	324/158.1
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	IBM Technical Disclosure, "AC Chip in Place Test", NN74111607, November, 1974.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
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